

# Base Material Line Up



## SML02G(X)/ SML02GB(X)

### 1. CORE (C-STAGE)

Thickness		ply-up	RC(%)	Dk				Df			
mm	mil			1GHz	3GHz	5GHz	10GHz	1 GHz	3 GHz	5 GHz	10GHz
0.051	2.00	1*106	75%	3.99	3.96	3.94	3.90	0.0081	0.0088	0.0090	0.0095
0.064	2.50	1*106	80%	3.90	3.86	3.85	3.81	0.0077	0.0081	0.0083	0.0090
0.076	3.00	1*1080	68%	4.10	4.09	4.08	4.06	0.0090	0.0093	0.0094	0.0098
0.076	3.00	2*1027	73%	4.02	4.02	4.01	3.96	0.0086	0.0090	0.0091	0.0095
0.089	3.50	2*1027	77%	3.99	3.94	3.91	3.87	0.0081	0.0084	0.0086	0.0092
0.102	4.00	1*3313	60%	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100
0.102	4.00	2*106	75%	3.99	3.96	3.94	3.90	0.0081	0.0088	0.0090	0.0095
0.114	4.50	1*3313	64%	4.25	4.22	4.20	4.16	0.0090	0.0094	0.0095	0.0098
0.114	4.50	1*2116	56%	4.44	4.42	4.41	4.36	0.0095	0.0098	0.0100	0.0102
0.127	5.00	1*2116	60%	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100
0.127	5.00	2*106	80%	3.90	3.86	3.85	3.81	0.0077	0.0081	0.0083	0.0090
0.152	6.00	2*1080	68%	4.10	4.09	4.08	4.06	0.0090	0.0093	0.0094	0.0098
0.152	6.00	1*1506	49%	4.63	4.60	4.59	4.55	0.0100	0.0103	0.0103	0.0106
0.178	7.00	2*1080	72%	4.03	4.02	4.00	3.96	0.0086	0.0093	0.0095	0.0097
0.203	8.00	2*3313	60%	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100
0.203	8.00	1*7628	52%	4.56	4.54	4.53	4.48	0.0099	0.0100	0.0102	0.0104
0.254	10.00	2*2116	60%	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100
0.305	12.00	2*1506	49%	4.63	4.60	4.59	4.55	0.0100	0.0103	0.0103	0.0106
0.305	12.00	3*3313	60%	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100

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0.381	15.00	3*2116	60%	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100
0.406	16.00	2*7628	52%	4.56	4.54	4.53	4.48	0.0099	0.0100	0.0102	0.0104
0.457	18.00	4*2116	56%	4.44	4.42	4.41	4.36	0.0095	0.0098	0.0100	0.0102
0.508	20.00	4*2116	60%	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100
0.610	24.00	3*7628	52%	4.56	4.54	4.53	4.48	0.0099	0.0100	0.0102	0.0104
0.635	25.00	5*2116	60%	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100
0.711	28.00	4*1506	55%	4.48	4.46	4.44	4.38	0.0096	0.0100	0.0101	0.0102
0.762	30.00	6*2116	60%	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100
0.813	32.00	4*7628	52%	4.56	4.54	4.53	4.48	0.0099	0.0100	0.0102	0.0104
0.914	36.00	8*2116	56%	4.44	4.42	4.41	4.36	0.0095	0.0098	0.0100	0.0102
1.016	40.00	8*2116	60%	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100
1.016	40.00	5*7628	52%	4.56	4.54	4.53	4.48	0.0099	0.0100	0.0102	0.0104
1.143	45.00	9*2116	60%	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100
1.219	48.00	6*7628	52%	4.56	4.54	4.53	4.48	0.0099	0.0100	0.0102	0.0104
1.372	54.00	9*1506	49%	4.63	4.60	4.59	4.55	0.0100	0.0103	0.0103	0.0106
1.422	56.00	7*7628	52%	4.56	4.54	4.53	4.48	0.0099	0.0100	0.0102	0.0104
1.524	60.00	8*1506	58%	4.39	4.37	4.36	4.33	0.0094	0.0097	0.0099	0.0101
1.524	60.00	10*1506	49%	4.63	4.60	4.59	4.55	0.0100	0.0103	0.0103	0.0106
1.524	60.00	12*2116	60%	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100
1.626	64.00	8*7628	52%	4.56	4.54	4.53	4.48	0.0099	0.0100	0.0102	0.0104

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## 2. PREPREG (B-STAGE)

Glass style	RC (%) Nominal	Thickness		Dk				Df			
		mm	mil	1GHz	3GHz	5GHz	10GHz	1 GHz	3 GHz	5 GHz	10GHz
106	75%	0.051	2.00	3.99	3.96	3.94	3.90	0.0081	0.0088	0.0090	0.0095
	78%	0.058	2.30	3.95	3.92	3.89	3.85	0.0080	0.0083	0.0084	0.0091
	80%	0.064	2.50	3.90	3.86	3.85	3.81	0.0077	0.0081	0.0083	0.0090
	83%	0.076	3.00	3.84	3.81	3.79	3.75	0.0076	0.0078	0.0081	0.0089
	85%	0.089	3.50	3.80	3.76	3.75	3.71	0.0073	0.0076	0.0078	0.0087
	88%	0.104	4.10	3.76	3.72	3.69	3.65	0.0070	0.0073	0.0075	0.0081
1067	75%	0.064	2.50	3.99	3.96	3.94	3.90	0.0081	0.0088	0.0090	0.0095
	78%	0.071	2.80	3.95	3.92	3.89	3.85	0.0080	0.0083	0.0084	0.0091
1080	68%	0.076	3.00	4.10	4.09	4.08	4.06	0.0090	0.0093	0.0094	0.0098
	70%	0.081	3.20	4.09	4.07	4.06	4.02	0.0089	0.0092	0.0094	0.0098
	72%	0.089	3.50	4.03	4.02	4.00	3.96	0.0086	0.0093	0.0095	0.0097
	75%	0.102	4.00	3.99	3.96	3.94	3.90	0.0081	0.0088	0.0090	0.0095
1086	72%	0.094	3.70	4.03	4.02	4.00	3.96	0.0086	0.0093	0.0095	0.0097
	75%	0.107	4.20	3.99	3.96	3.94	3.90	0.0081	0.0088	0.0090	0.0095
3313	60%	0.102	4.00	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100
	62%	0.107	4.20	4.30	4.27	4.25	4.21	0.0092	0.0095	0.0097	0.0099
	64%	0.114	4.50	4.25	4.22	4.20	4.16	0.0090	0.0094	0.0095	0.0098
2116	56%	0.114	4.50	4.44	4.42	4.41	4.36	0.0095	0.0098	0.0100	0.0102
	60%	0.127	5.00	4.34	4.32	4.30	4.26	0.0092	0.0095	0.0098	0.0100
	62%	0.135	5.30	4.30	4.27	4.25	4.21	0.0092	0.0095	0.0097	0.0099

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	64%	0.145	5.70	4.25	4.22	4.20	4.16	0.0090	0.0094	0.0095	0.0098
1506	49%	0.152	6.00	4.63	4.60	4.59	4.55	0.0100	0.0103	0.0103	0.0106
	52%	0.165	6.50	4.56	4.54	4.53	4.48	0.0099	0.0100	0.0102	0.0104
	55%	0.178	7.00	4.48	4.46	4.44	4.38	0.0096	0.0100	0.0101	0.0102
	58%	0.191	7.50	4.39	4.37	4.36	4.33	0.0094	0.0097	0.0099	0.0101
7628	52%	0.203	8.00	4.56	4.54	4.53	4.48	0.0099	0.0100	0.0102	0.0104
	54%	0.216	8.50	4.50	4.48	4.47	4.41	0.0097	0.0100	0.0101	0.0102

## 3. REMARK

- 1) Test method: IPC-TM-650 2.5.5.5;
- 2) Copper foil:HTE, RTF;
- 3) Copper foil thickness:1/2oz,1oz and 2oz;
- 4) All the values listed above are for your reference only. Please contact Shengyi Technology Co., Ltd. for detailed information. All rights from this line up are reserved by Shengyi Technology Co., Ltd.;
- 5) Last update: January, 2022.